

<b>Form 1449 (Modified)</b>  <b>Information Disclosure Statement By Applicant</b>  (Use Several Sheets if Necessary)	Atty. Docket No. AGLE0027	Serial No.: 09/909,774
	Applicant: Chaiken et al.	
	Filing Date: July 19, 2001	Group: 2454 2187

### U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
DAP <del>RE</del>	A	4,695,944	9/22/87	Zandveld et al.	364	200	9/22/86
DAP <del>RE</del>	B	4,723,238	2/2/88	Israel et al.	370	60	3/24/86
DAP <del>RE</del>	C	4,821,265	4/11/89	Albal et al.	370	110.1	4/6/87
DAP <del>RE</del>	D	4,903,258	2/20/90	Kuhlmann et al.	370	58.2	8/19/88
DAP <del>RE</del>	E	4,907,225	3/6/90	Gulick et al.	370	94.1	6/16/89
DAP <del>RE</del>	F	4,939,728	7/3/90	Markkula, Jr. et al.	370	94.3	12/19/88
DAP <del>RE</del>	G	4,949,338	8/14/90	Albal et al.	370	85.6	11/14/88
DAP <del>RE</del>	H	4,955,018	9/4/90	Twitty et al.	370	85.1	11/8/88
DAP <del>RE</del>	I	4,962,497	10/9/90	Ferenc et al.	370	60.1	9/21/89
DAP <del>RE</del>	J	4,984,237	1/8/91	Franaszek	370	60	6/29/89
DAP <del>RE</del>	K	4,993,017	2/12/91	Bachinger et al.	370	58.2	2/22/89
DAP <del>RE</del>	L	5,093,827	3/3/92	Franklin et al.	370	60.1	9/21/89
DAP <del>RE</del>	M	5,124,978	6/23/92	Chao	370	60	1/3/91
DAP <del>RE</del>	N	5,130,984	7/14/92	Cisneros	370	94.1	152/18/90
DAP <del>RE</del>	O	5,157,654	10/20/92	Cisneros	370	60	12/18/90
DAP <del>RE</del>	P	5,179,552	1/12/93	Chao	370	60	1/10/92
DAP <del>RE</del>	Q	5,208,650	3/27/01	Hassell et al.	370	392	4/2/98
DAP <del>RE</del>	R	5,408,609	4/18/95	Malgogne et al.	395	200	12/19/91
DAP <del>RE</del>	S	5,630,061	5/13/97	Richter et al.	395	200.02	4/19/93
DAP <del>RE</del>	T	5,719,860	2/17/98	Maison et al.	370	347	3/22/96
DAP <del>RE</del>	U	5,793,770	8/11/98	St. John et al.	370	401	11/18/96
DAP <del>RE</del>	V	5,844,888	12/1/98	Markkula, Jr. et al.	370	255	6/7/95
DAP <del>RE</del>	W	5,894,474	4/13/99	Maison et al.	370	347	12/20/97
DAP <del>RE</del>	X	6,015,300	1/18/00	Schmidt, Jr. et al.	439	61	8/28/97
DAP <del>RE</del>	Y	6,091,729	7/18/00	Dove	370	395	11/26/97
DAP <del>RE</del>	Z	6,141,691	10/31/00	Frink et al.	709	233	4/3/98

### Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
							Yes	No
DAP <del>RE</del>	a	0621713	26/10/94	EPO	29	06		X
DAP <del>RE</del>	b	0285330	05/10/8	EPO	11	04		X

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Ex: DHAIYA A. PATEL

Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
DAF <del>RE</del>	c	*AMD Discloses New Technologies at Microprocessor Forum; October 5, 1999; AMD - News Release #99105; <a href="http://www.amd.com/news/prodpr/99105.html">http://www.amd.com/news/prodpr/99105.html</a> ; Printout from INSPEC.
DAF <del>RE</del>	d	*HyperTransport " Technology Frequently Asked Questions; <a href="http://www1.amd.com/products/cpg/showall/1,1395,,00.html?type=HyperTransport">http://www1.amd.com/products/cpg/showall/1,1395,,00.html?type=HyperTransport</a> ; Printout from INSPEC.
DAF <del>RE</del>	e	*Jayant Matthew; <u>API NetWorks Introduces the First HyperTransport-to-PCI Bridge Chip</u> ; Electronic News; April 2, 2001; Print out from INSPEC.
DAF <del>RE</del>	f	*Darrell Dunn; <u>API Revving Up Hypertransport Bus - - Looks to raise interest in the technology via chip that links it to PCI</u> ; EBN; April 2, 2001; Print out from INSPEC.
DAF <del>RE</del>	g	*Jerry Ascierio; <u>Rival post-PCI plans spark talk of bus war</u> ; Electronic Engineering Times; April 2, 2001; Print out from INSPEC.
DAF <del>RE</del>	h	*Ken Popovich; <u>Intel puts bus plan in gear - Chip maker challenges AMD's HyperTransport Architecture in bid to replace PCI in PC's, servers</u> ; eWeek; March 12, 2001; INPEC printout.
DAF <del>RE</del>	i	*Ken Popovich; <u>HyperTransport speeds data transfer (Advanced Micro Devices Inc.)</u> ; eWeek; February 26, 2001; print out from INSPEC.
DAF <del>RE</del>	j	*Jayant Matthew; <u>AMD Unveils Speedy Chip-to-Chip Link</u> ; Electronic News; February 19, 2001; Print out from INPSEC.
DAF <del>RE</del>	k	*Linley Gwennap; <u>AMD strikes Lightning</u> ; Electronic Engineering Times; February 19, 2001; print out from INSPEC.
DAF <del>RE</del>	l	*Jerry Ascierio; <u>Rival post-PCI plans spark talk of bus war</u> ; Electronic Engineering Times; 2001, n 1160, April 2, 2001; print out from INSPEC.
DAF <del>RE</del>	m	*Dave Polifko ; <u>The Optical Internet: Taking Up Where SONET Leaves Off</u> ; Telecommunications; June 2000; print out from INSPEC.
DAF <del>RE</del>	n	*Chu-Sun Yen, Richard C. Walker, Patrick T. Petrino; Cheryl Stout; Benny W.H. Lai; and William J. McFarland; <u>G-Link: A chipset for gigabit-rate data communication</u> ; Hewlett-Packard Journal; October 1992; print out from INSPEC.
DAF <del>RE</del>	o	*Mark Miller; <u>Which route for routers?</u> ; <u>Buyer's Guide, As vendors relocate the function of routers, look for those devices to take on many new faces</u> ; Network World; august 28, 1995; INSPEC print out.

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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